

# **Beyond ISMI: Electric Current Capacity of Vertical Probes Under Pulses and Transient Signals**





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### **Semiconductor Trends Influencing CCC**



\* Zeman SWTW2010 "A New Methodology for Assessing the Current Carrying Capability of Probes used at Sort"



- Keeping CCC for < 100µm Pitch is really hard
- Need to design efficiently to keep pace
  - Requires smarter probe design
  - Requires smarter communication between test customers & suppliers



# How are Things Done Today?

### • ISMI CCC Test standard:



**Presented at SWTW in 2009, the goal of the ISMI guideline is** "...to minimize variability in the measurement of this critical parameter... With a focus on reproducible measurements, this guideline provides CCC ratings that are inherently different from what a user will see in a production environment."\*

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 Test suppliers/customers develop internal "rules of thumb" to convert intended chip current into equivalent ISMI rating.

\* Daniels, E Boyd, 2009. *ISMI Probe Council Current Carrying Capability Measurement Standard*. San Diego, CA, June 7-10 2009, IEEE SW Test Workshop.



# **Influence of CCC on Probe Design**

#### Design "Points"



- Because the physics involved are nonlinear and start to "kick in" < 100µm pitch, the rules-of-thumb will become increasingly less useful.
- Need to elevate the level of discussion and understanding with regard to CCC between test suppliers and customers.

Probe design is all about proper allocation of design "points"



CCC





- Under-performing CCC = very bad, burnt probes
- Over-performing = still bad, comes at cost of probe stiffness & max OT



# **Objectives & Goals**

 Root cause of probe burns often lies in wafer-level defects causing unpredictable surges in current\*



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- Goal is to understand & share learning on how CCC behaves against the full spectrum of square-wave signals.
  - <u>Present Day</u>: Develop & verify a multiphysics model that can handle any type of specified signal.
  - <u>Long Term</u>: Construct a full multiphysics probe card model to convert Chip Requirements --> Spring Design --> ISMI Rating



### Failure Modes: DC vs Square-Wave

### • DC Failure Mode:

Reduction in contact force from heating in high stress locations of spring



### • Square-Wave Failure Modes:

- Long Duration Pulse = Reduction in contact force
- Short Duration Pulse = Tip melting









### **Overview of Test Methods & Procedure**

• Multiphysics Simulation Calibration Steps:

- Using ANSYS & Solidworks Flow Simulation, built a model that matched ISMI testing for all our probe products. This gave insight into temp rise/fall times.
- Ran experiment for CCC vs Pulse ON length
- Refined model to match all test cases for the same contact constraints
- Used model to generate CCC behavior for any specified signal
- Quantified this behavior for one of our probe products for presentation today. CCC<sub>ISMI</sub> = 0.8A



### **Results Overview**

### Important Insight:

 Probe behavior most easily understood based on the relationship between probe cooling and OFF duration between pulses.

### • For the probe presented:

- Time to cool  $\approx$  100ms ( $\tau$  = 25ms)

### Can classify any square wave into 3 groups:

- <u>Isolated Pulses</u>: Time between events is long enough that the probe carries no significant heat between pulses. ( $f \le 10 \text{ Hz}, T \ge 100 \text{ms}$ )
- <u>Hi-Speed Signals</u>: Time between events is short enough that the probe experiences only small  $\Delta T$  between pulses. ( $f \ge 1 \ kHz$ ,  $T \le 1ms$ )
- Intermediate Signals: Consists of the remainder. Time between events is such that the probe experiences large  $\Delta T$  & carries residual heat between pulses. (f = 10 Hz 1 kHz, T = 100ms 1ms)



### **Isolated Pulses: Definition**

#### • Definition:

- Time between events is long enough that the probe carries no significant heat between pulses. ( $f \le 10 \text{ Hz}, T \ge 100 \text{ms}$ )
- Analogous to capacitor discharge or not fully powering down between touchdowns ("hot stepping")
- Most important signal class to understand in order to prevent burnt probes



### **Isolated Pulses: Procedure**

### Experimentally measured CCC for Isolated Pulses:

- ON Duration: 20ms, 10ms, 1ms, 0.1ms
- OFF Duration: 100ms
- Procedure:
  - Signal Run for 1min  $\rightarrow$  Check Force  $\rightarrow$  Increase Current  $\rightarrow$  Repeat Until Failure
- Probe subjected to ~545 pulses at each current level before re-checking force and increasing current further



### **Isolated Pulses: Results**



- SWTW
- Probes survived 550 pulses at 4.0 A, if duration is  $\leq$  1ms.
- 400% increase in CCC over ISMI rating of that product!
- June 9 12, 2013 IEEE Workshop
- Starting at ~5.0 A, 0.1ms pulse we start seeing melted tips

# **Isolated Pulses: Behavior**



### **Isolated Pulses: Comments**

- There exists a practical limit on CCC for isolated pulses where max current can no longer be increased by a decrease in pulse length due to instantaneous melting at the tip.
  - For the product shown this practical limit is ~5.0 A for a 0.1n pulse
- There exists a transition point where the probe failure mechanism changes from loss of contact force to tip melting.
  - For the product shown here that point is a 4.0 A, 1ms duration pulse.

#### • Dominating factors:

- Pulse Width & Spring Design
- Isolated pulses can be successfully predicted and understood using a multiphysics simulation software

1ms - 4.0 A

# **Hi-Speed Signals: Definition**

#### • Definition:

- Time between events is short enough that the probe experiences only small  $\Delta T$  between pulses. ( $f \ge 1 \ kHz, T \le 1ms$ )
- Analogous to a fast logic signal
- Hi-Speed signals represent the most common intended signals
  - Understanding CCC behavior for signals operating at speeds > 1 kHz will help tailor probe designs used at these locations.



If we assume small ΔT between pulses, CCC for any duty cycle should follow the equation:

 $CCC\downarrow HiSpeed = \sqrt{CCC\downarrow ISMI}$ 

# **Hi-Speed Signals: Results**



- Simulation & Experimental tests closely follow the  $cretical is pred = \sqrt{Cl}$  equation for equivalent energy input
  - Significant increase in CCC for Duty Cycles < 30%
- Behaves thermally like a DC input

### **Intermediate Signals: Definition**

#### • Definition:

- Consists of the remainder of signals that do not qualify to be either "isolated" or "Hi-Speed."
- Time between events is such that the probe experiences large  $\Delta T$  & carries residual heat between pulses. (f = 10 Hz 1 kHz, T = 100ms 1ms)

#### • Most complex to analyze:

- Temperature "walks upward" with each pulse, but at a rate unique to that signal condition & probe design.
- Number of pulses to reach steady-state can range from just a handful to several hundred
- Thankfully these are the least likely signal types to be used on a probe card



# **Intermediate Signal: Results**



- This particular signal condition reaches steady-state in 3 cycles
  - Max CCC for 5ms ON / 45ms OFF = 1.5 A
- Intermediate signals will always have a lower CCC than the equivalent Isolated Pulse or Hi-Speed Signal
  - 5ms pulse width for Isolated Pulse = 1.75 A
  - 10% Duty Cycle for Hi-Speed = 2.5 A



# **Summary & Conclusion**

- CCC can be greatly influenced by the specific signal used on a probe
- Shown that CCC of a probe can be increased by as much as 400% given the proper signal condition
- The CCC of any arbitrary signal can be modeled successfully using a multiphysics simulation software

#### • For vertical probe cards to continue to advance < 100um Pitch:

- Probe card suppliers should better understand their CCC capabilities for unpredictable surges in current
- Probe card customers can aid by providing as much information about the test conditions as possible



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Communication will become increasingly important for matching probe technology to product

### **Future Work**

- Collect additional experimental data to continue to validate the multiphysics simulation
- Consider defining a CCC characterization test for isolated pulses
  - Would need to better understand what a typical discharge event looks like
- Increase overall robustness and value of simulation to account for any combination of:
  - Heat from neighboring springs
  - Testing at elevated or reduced temperatures
  - Cres Variation
- Allow FormFactor/MicroProbe to evaluate very quickly:
  - − Product Needs → Spring Design → Equivalent ISMI → Test → Ship

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